

Image Processing and Computer Vision for Hardware Assurance

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- **Image Processing (IP):**

The processing of images using mathematical operations by using any form of signal processing for which the input is an image, a series of images or a video, such as a photograph or video frame; the output of image processing may be either an image or a set of characteristics or parameters related to the image. [1]

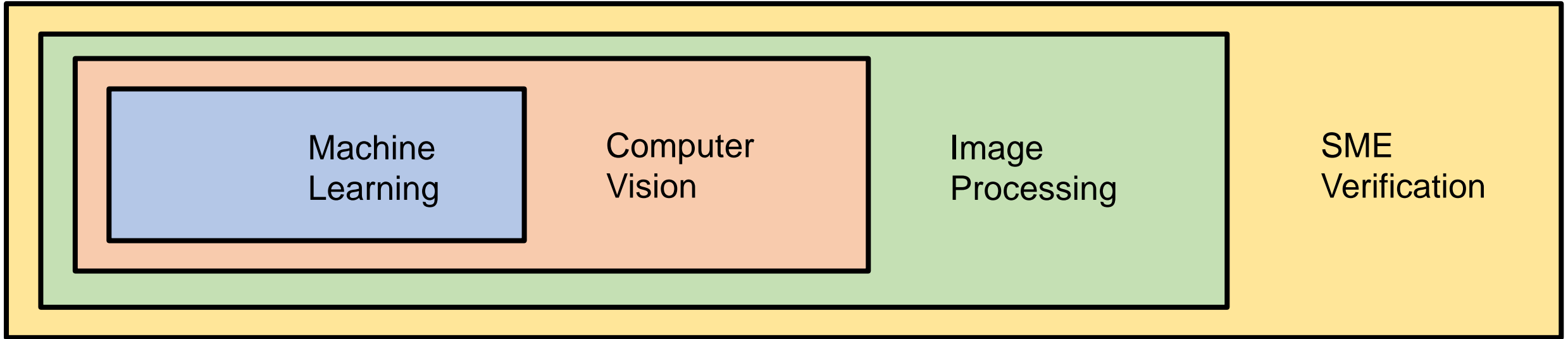
Basically: image in, image out

- **Computer Vision (CV):**

An interdisciplinary field that deals with how computers can be made for gaining high-level understanding from digital images or videos. From the perspective of engineering, it seeks to automate tasks that the human visual system can do. [1]

Basically: image in, knowledge out

IP/CV Role in HW Assurance [2]

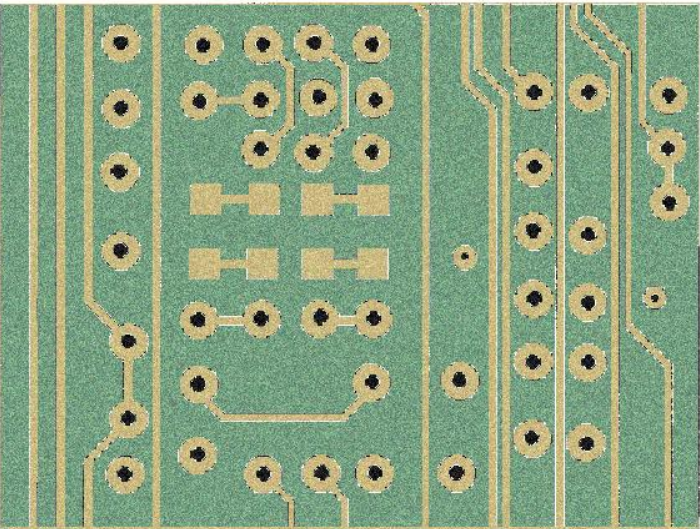


Stage Name	Machine Learning	Computer Vision	Image Processing	SME Verification
Used For	Sample Classification	Feature Extraction	Preprocessing	Multipurpose
Characteristics	<ul style="list-style-type: none"> • Can be fully automated • SME only needed for periodic random sampling • Widest range of applicability 	<ul style="list-style-type: none"> • Start of automated assurance • Output no longer resembles an image • Only minor SME input required 	<ul style="list-style-type: none"> • Clean noise in input image • Enhance appearance of defects • Still requires SME input 	<ul style="list-style-type: none"> • Burden of assurance is completely on the human • Only useful for low-throughput supply chains • Highly prone to error

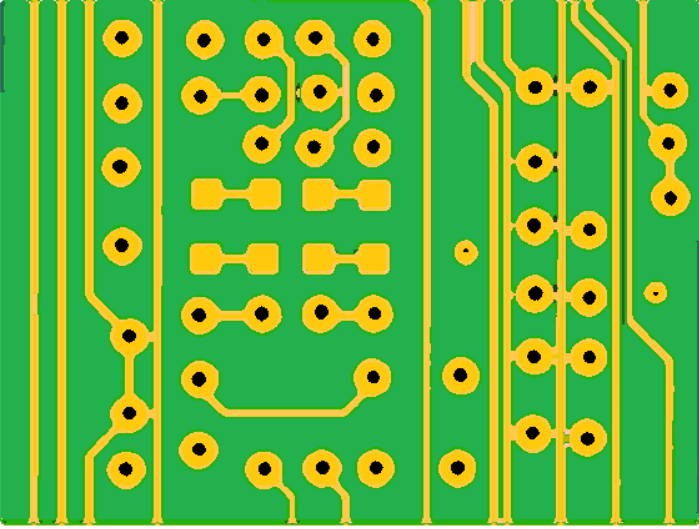
- **IC/PCB Verification Enhancement**
 - Preprocessing
 - Difference Imaging
 - Thresholding
 - Fault Detection
 - SME Verification

IC/PCB Verification: Preprocessing

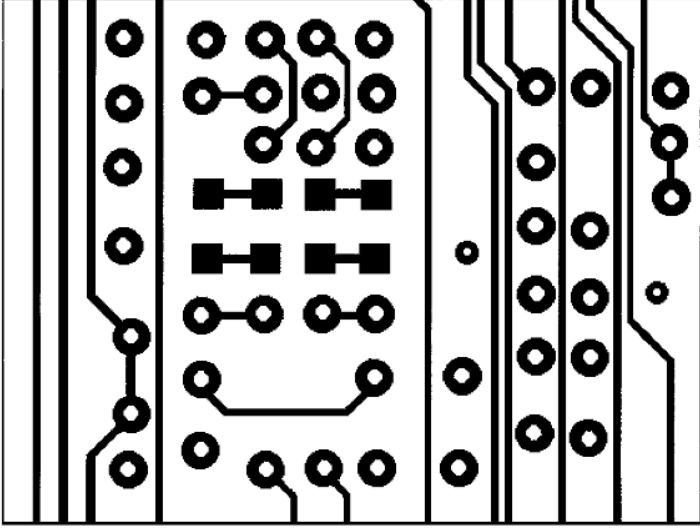
Original Image



Enhanced Image



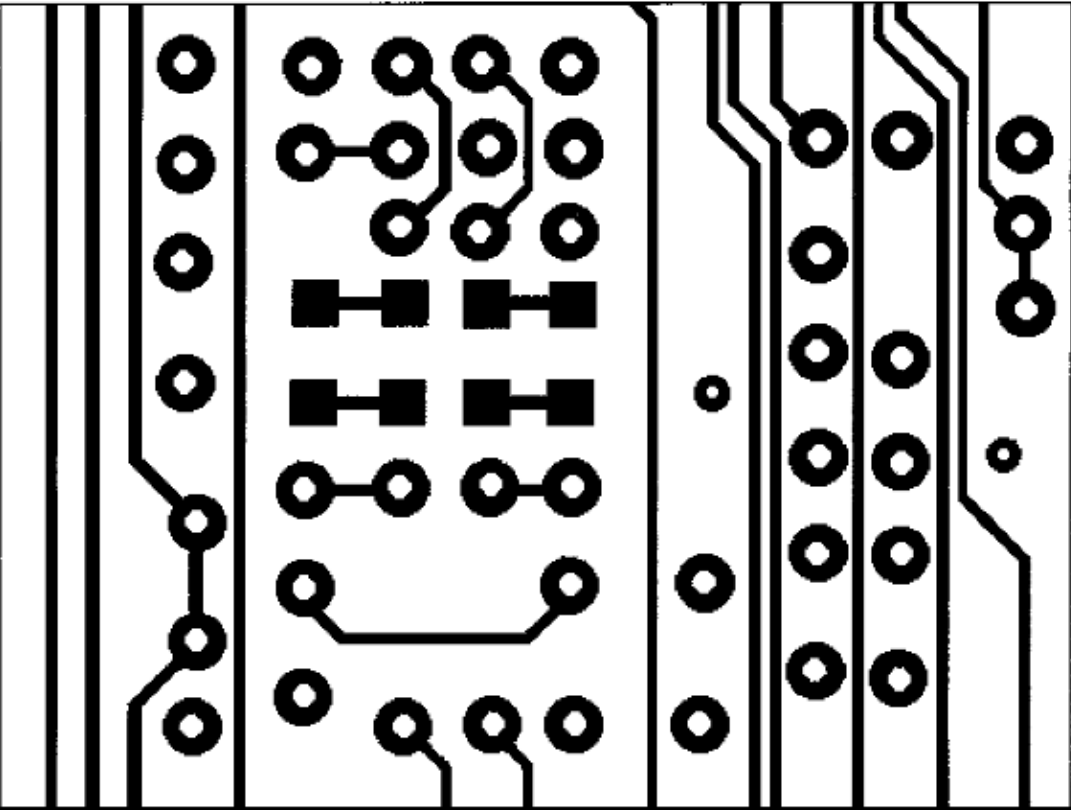
Processed Image



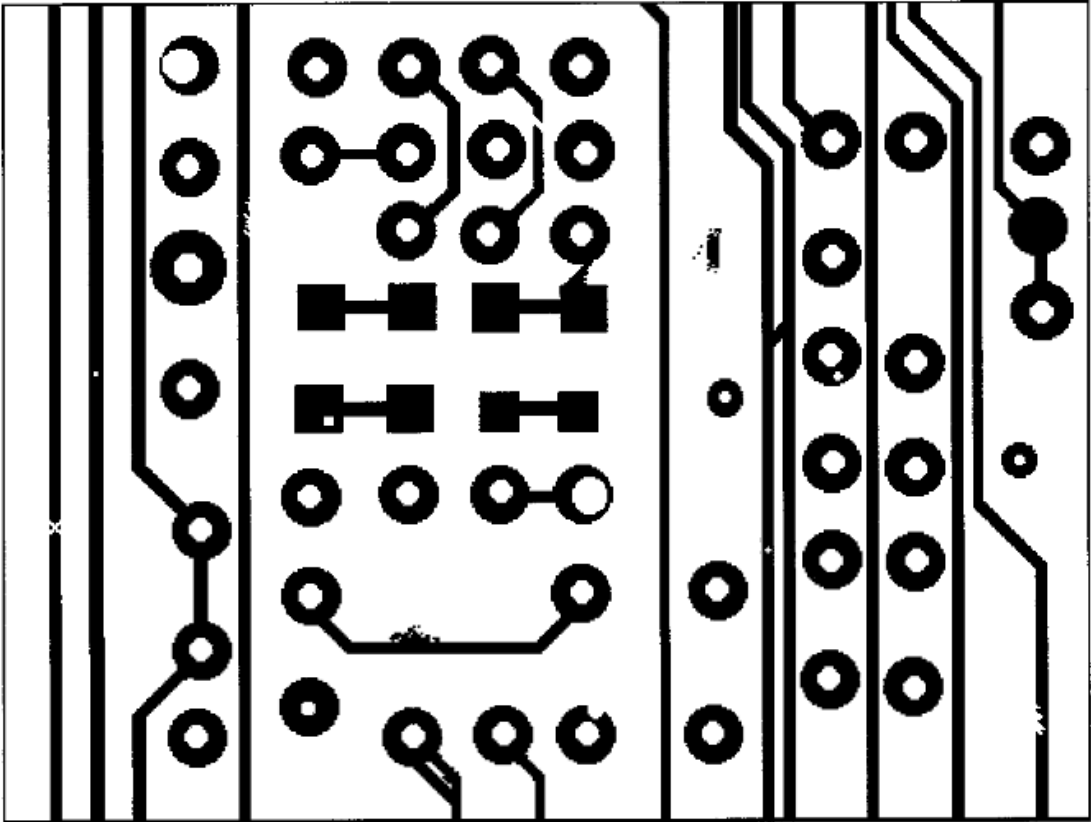
Deblurring,
Color Enhancement

Color Thresholding,
Binary Morphological
Image Processing

Processed Golden Sample



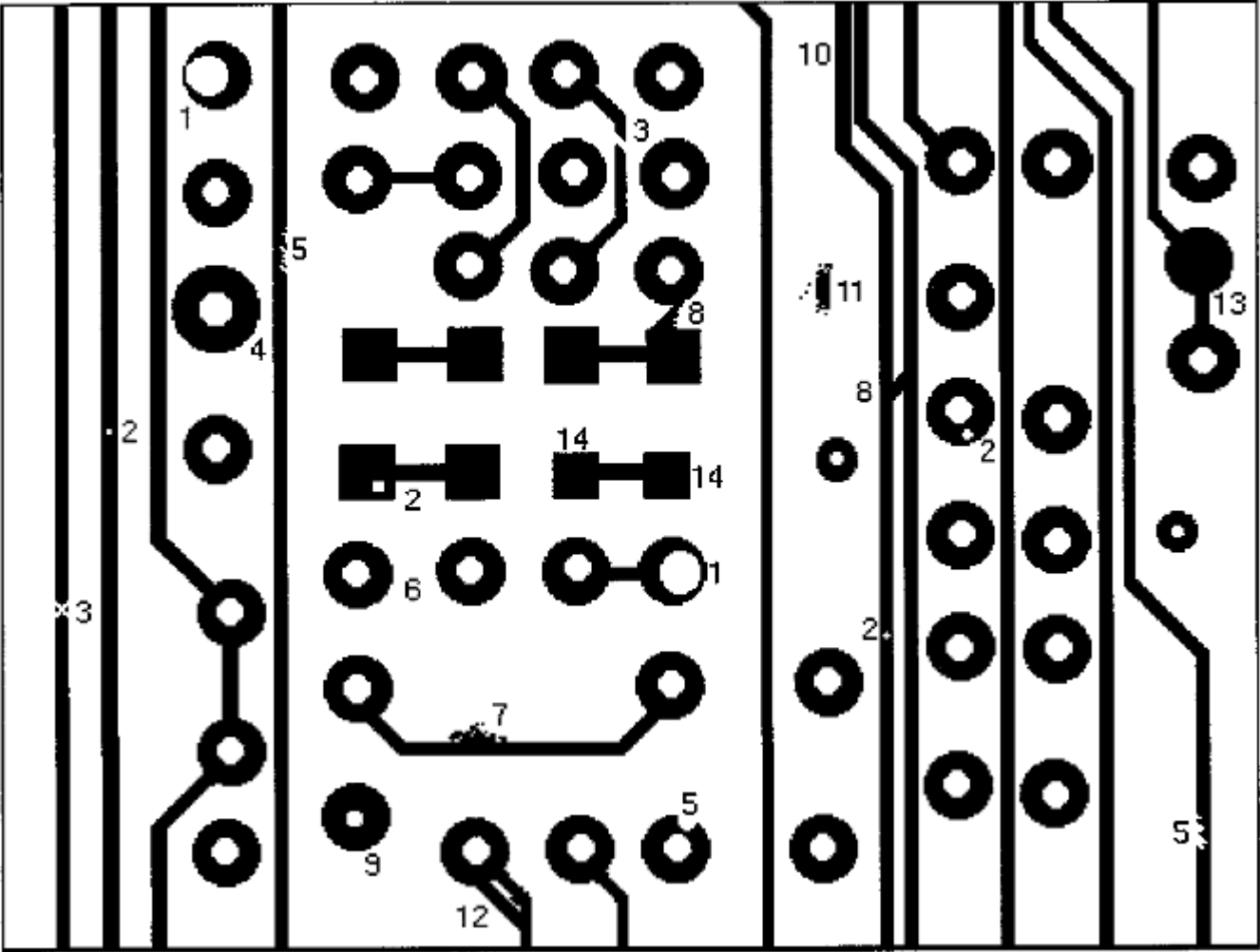
Processed Test Sample



XOR

Spot the difference!

Detected Faults

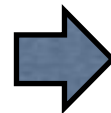
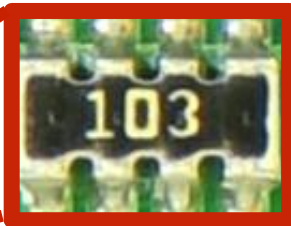
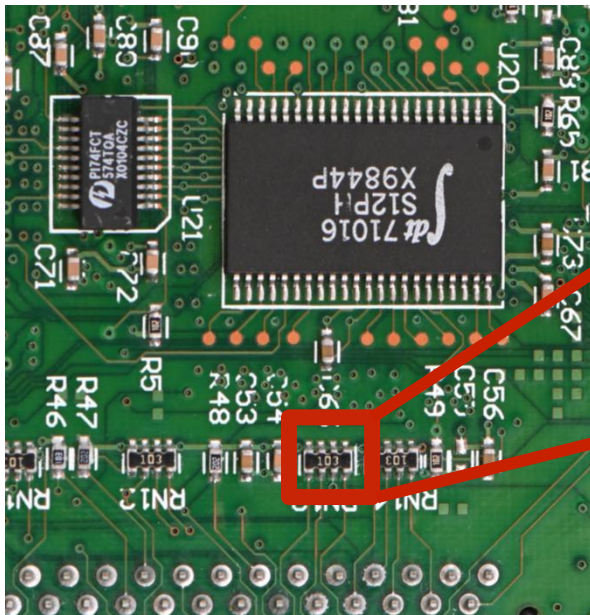


SME Notes

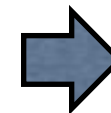
- 1. Breakout
- 2. Pin Hole
- 3. Open Circuit
- 4. Underetch
- 5. Mousebite
- 6. Missing Conductor
- 7. Spur
- 8. Short
- 9. Wrong Size Hole
- 10. Conductors too close
- 11. Spurious copper
- 12. Excessive Short
- 13. Missing Hole
- 14. Overetch

- **Bill of (BoM)**
 - **Definition:** list of all components present on a PCB, such as resistors, capacitors, and Integrated Circuits (ICs) [4]
 - **Applications [5]:**
 - Hardware Assurance (e.g. detection of hardware Trojans, tampering, or other malicious modifications)
 - reverse engineering (e.g. analysis of foreign, competitor, or legacy devices)
 - industrial assessment (e.g. cost estimation, quality assurance)
 - academia (e.g. technology trend analysis)
- **Goal: Automatic BoM Extraction (AutoBoM)**

- **Component Detection**
 - Localize the components
- **Component Classification**
 - Determine what type each component is
- **Component Identification**
 - Determine enough info about each component to roughly purchase the exact materials

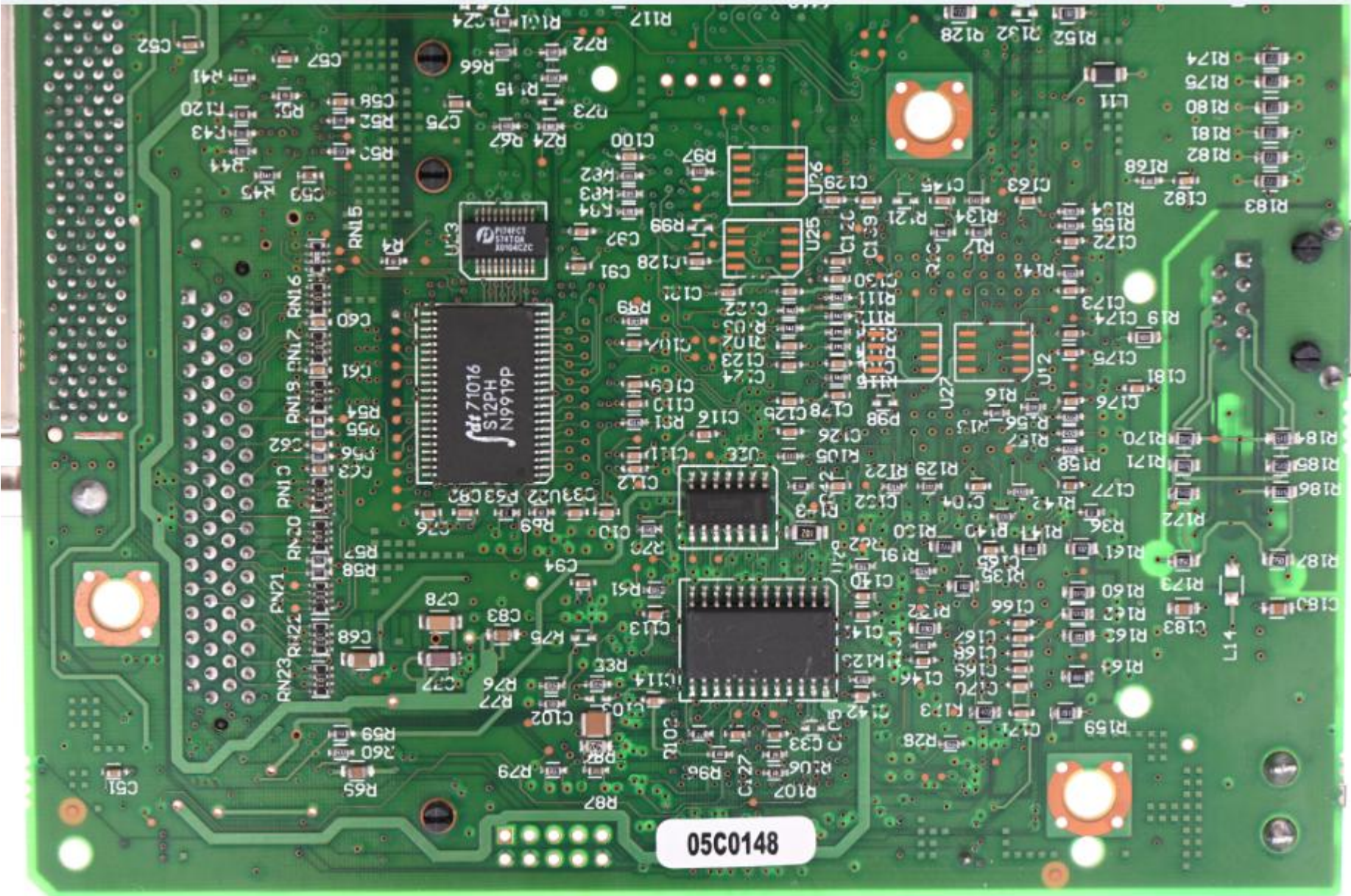


Resistor

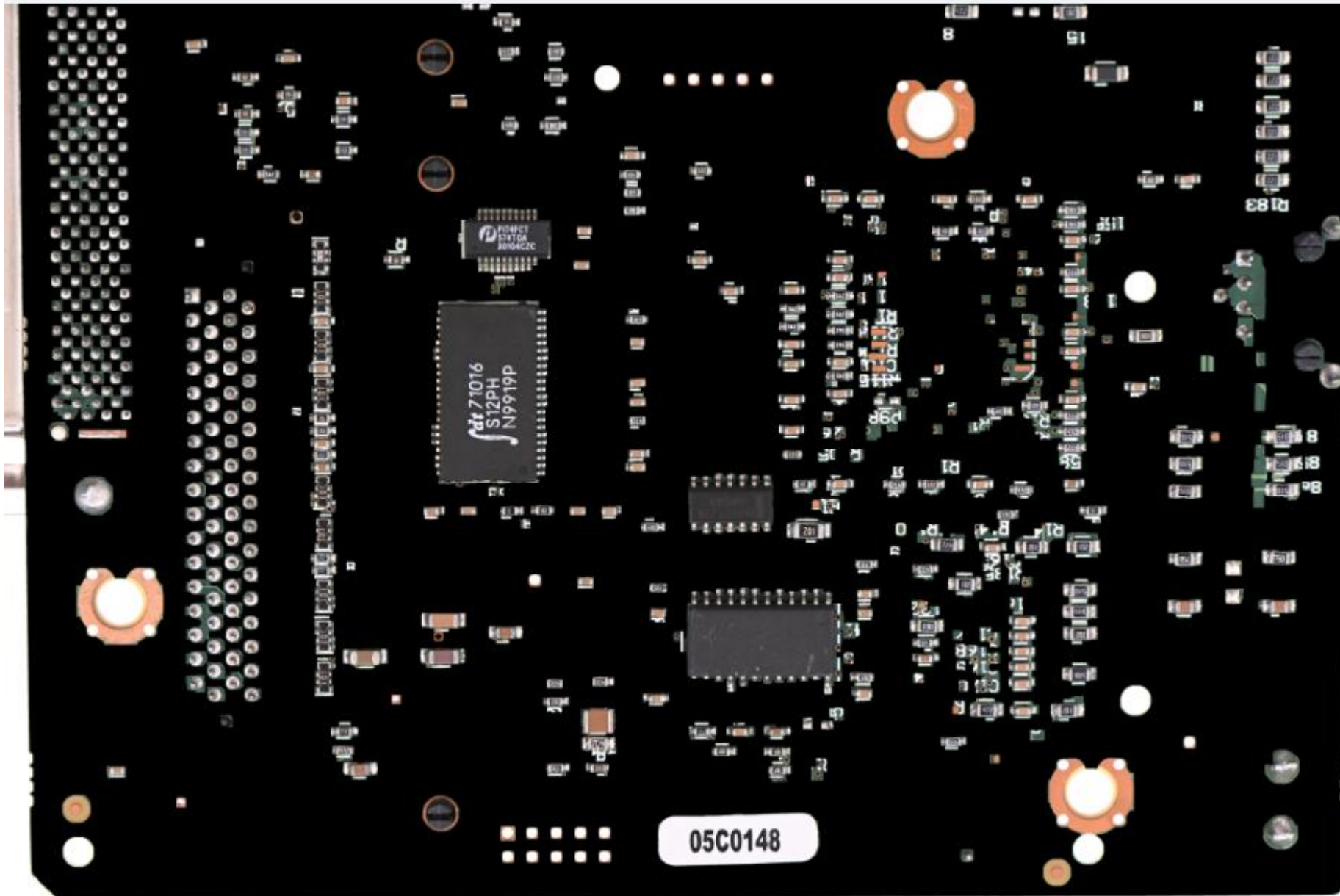


103 Ohm
Resistor
Network

AutoBoM: Component Detection



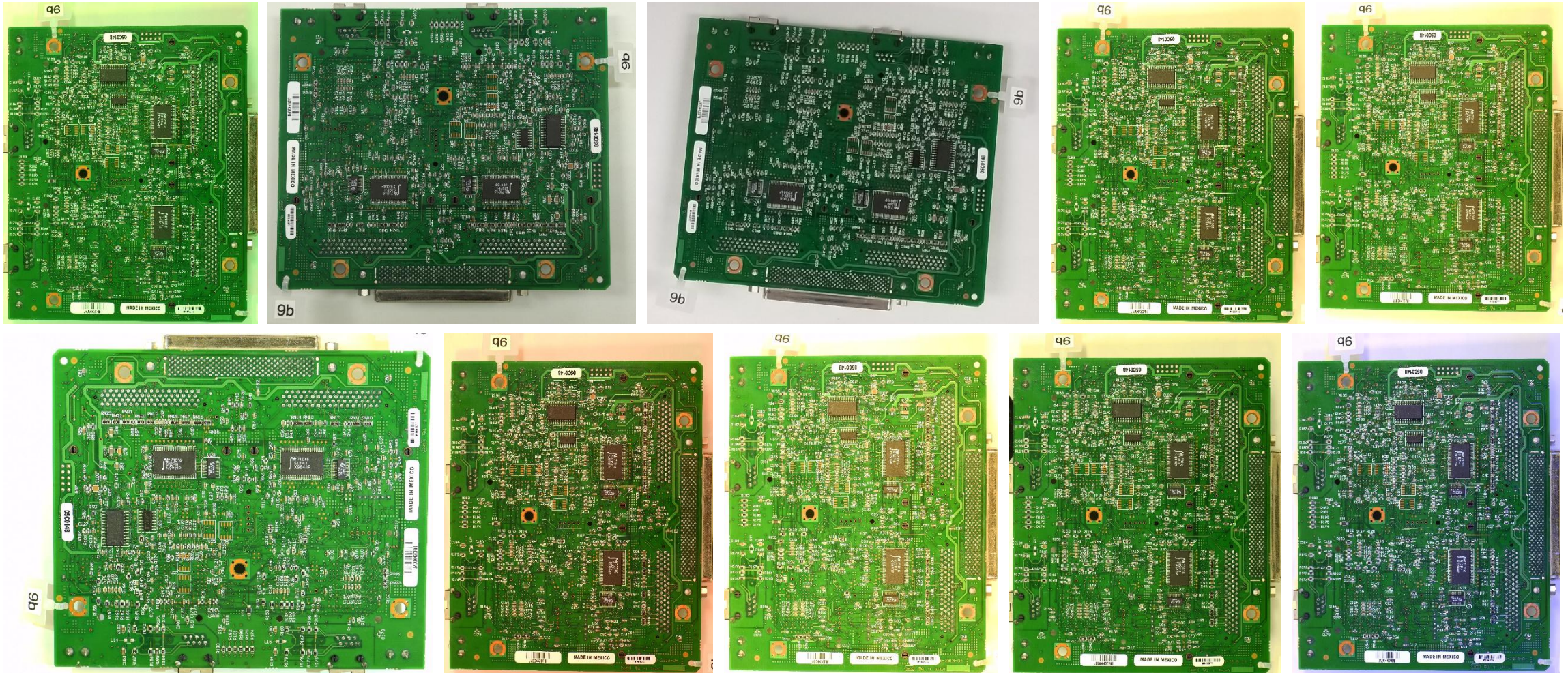
AutoBoM: Component Detection



> 99%
accuracy

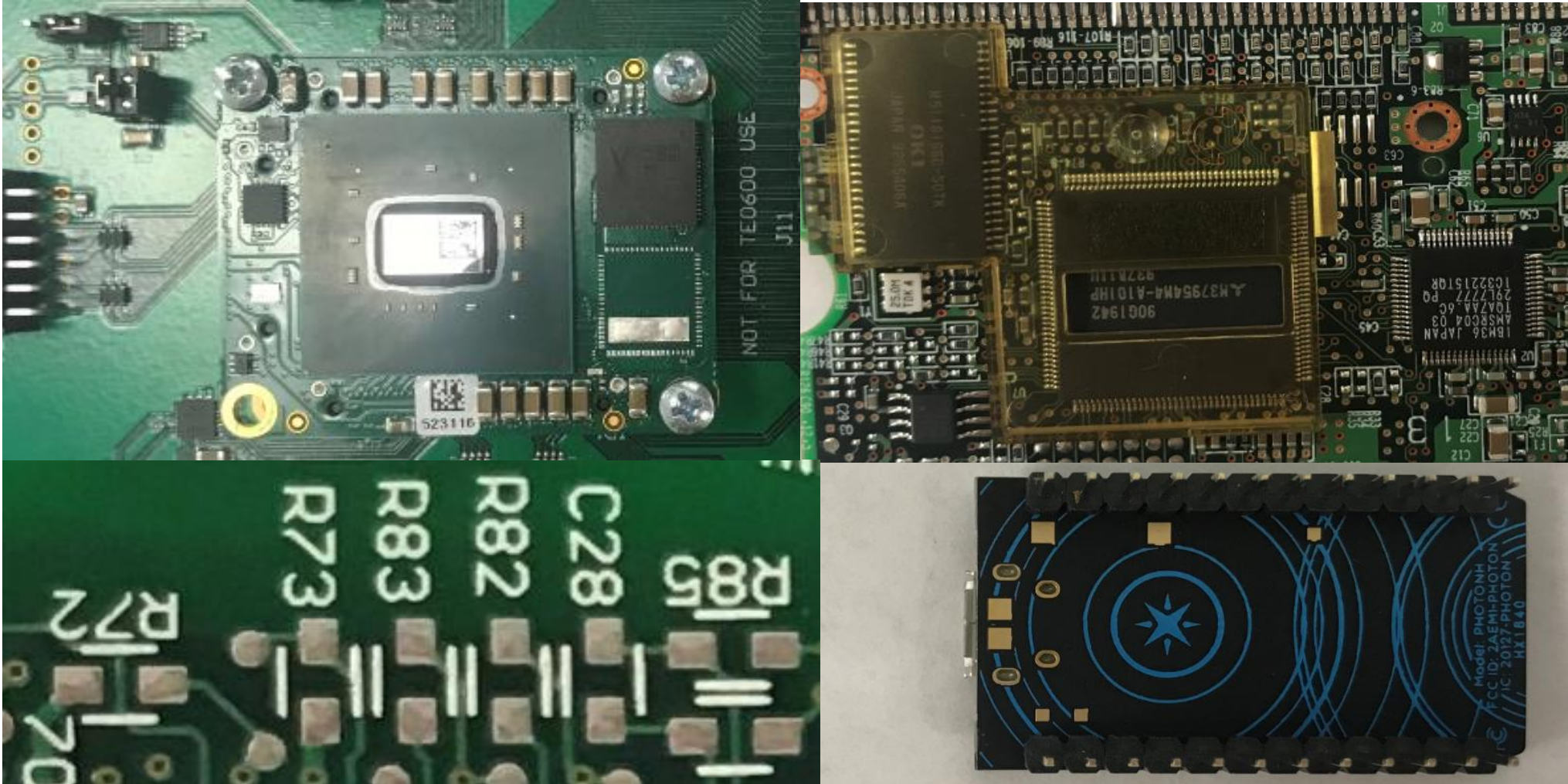
AutoBoM: Component Detection Challenges

- **Imaging Conditions:** camera type, lighting intensity, lighting color

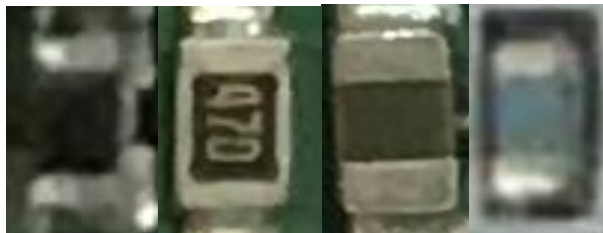
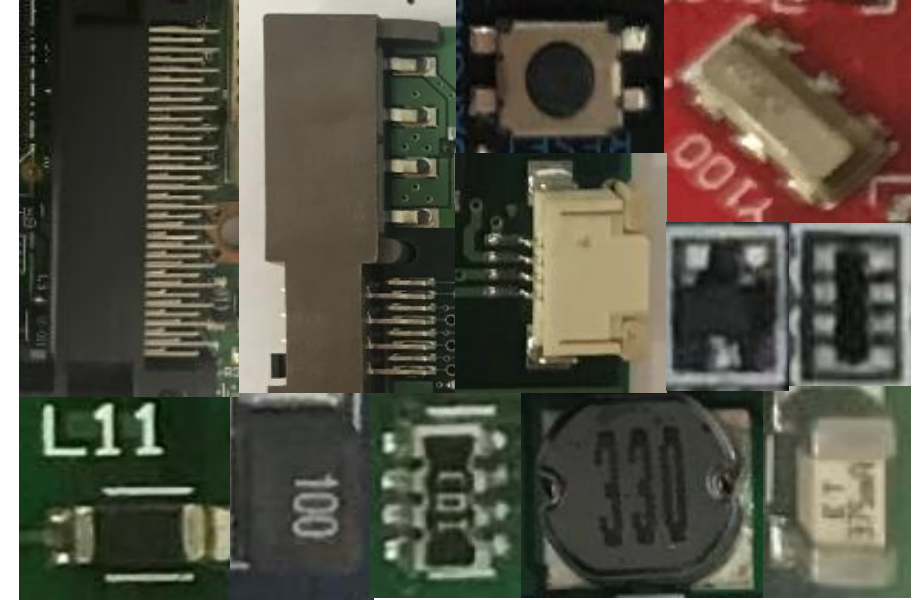
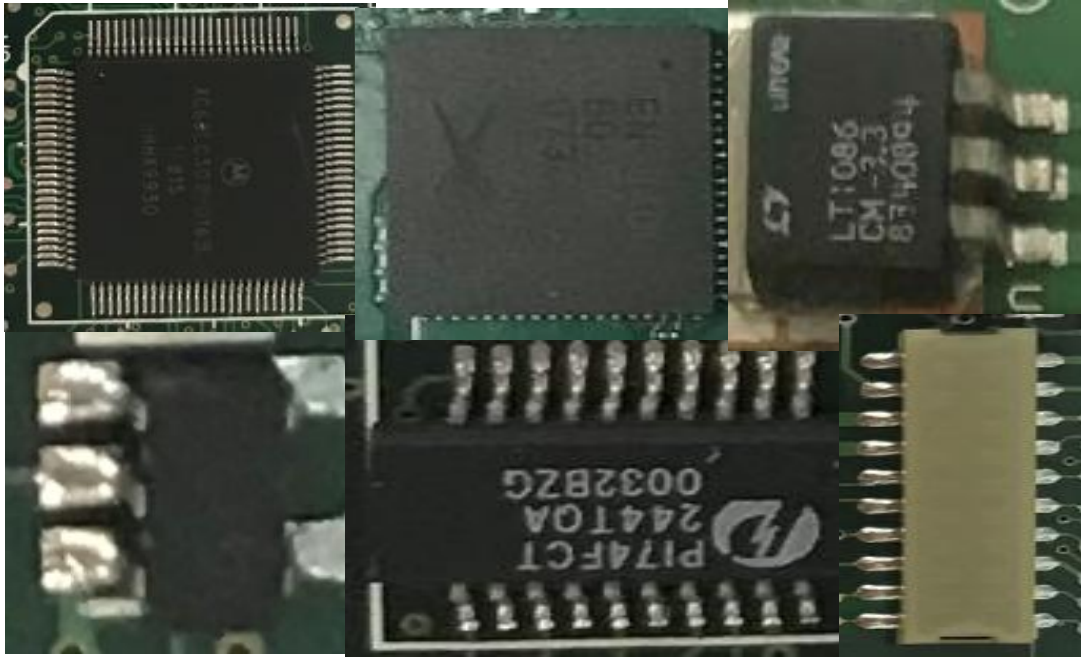


AutoBoM: Component Detection Challenges

- Inherent Board Variations



- Inherent Component Variations



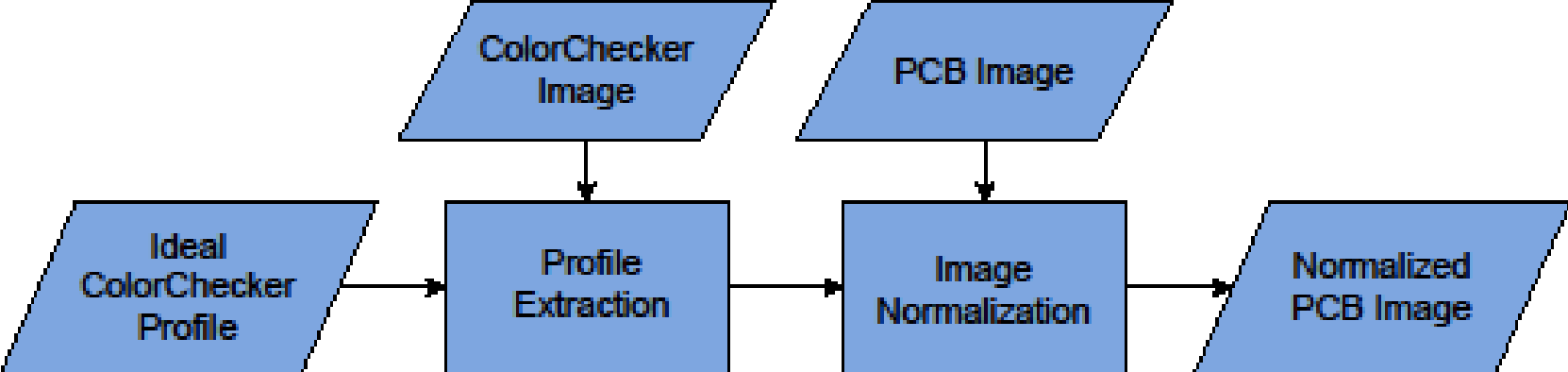
Imaging Conditions Solution: Color Checkers [6]

Color Checker Chart

Dark Skin R=115 G= 82 B= 68	Light Skin R=194 G=150 B=130	Blue Sky R= 98 G=122 B=157	Foliage R= 87 G=108 B= 67	Blue Flower R=133 G=128 B=177	Bluish Green R=103 G=189 B=170
Orange R=214 G=126 B= 44	Purple Red R= 80 G= 91 B=166	Moderate Red R=193 G= 90 B= 99	Purple R= 94 G= 60 B=108	Yellow Green R=157 G=188 B= 64	Orange Yellow R=224 G=163 B= 46
Blue R= 56 G= 61 B=150	Green R= 70 G=148 B= 73	Red R=175 G= 54 B= 60	Yellow R=231 G=199 B= 31	Magenta R=187 G= 86 B=149	Cyan R= 8 G=133 B=161
White R=243 G=243 B=242	Neutral 8 R=200 G=200 B=200	Neutral 65 R=160 G=160 B=160	Neutral 5 R=122 G=122 B=121	Neutral 35 R= 85 G= 85 B= 85	Black R= 52 G= 52 B= 52

X-Rite

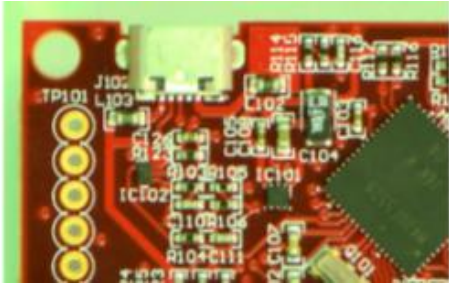
Imaging Conditions Solution: Color Checkers



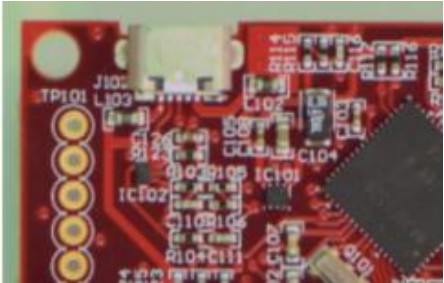
Solve Linear Regression

Non-Ideal C.C. Weights	red	green	blue
red	0.75	0.093	-0.066
green	0.066	0.72	0.0096
blue	0.019	0.053	0.76
Ideal C.C. Weights	red	green	blue

*

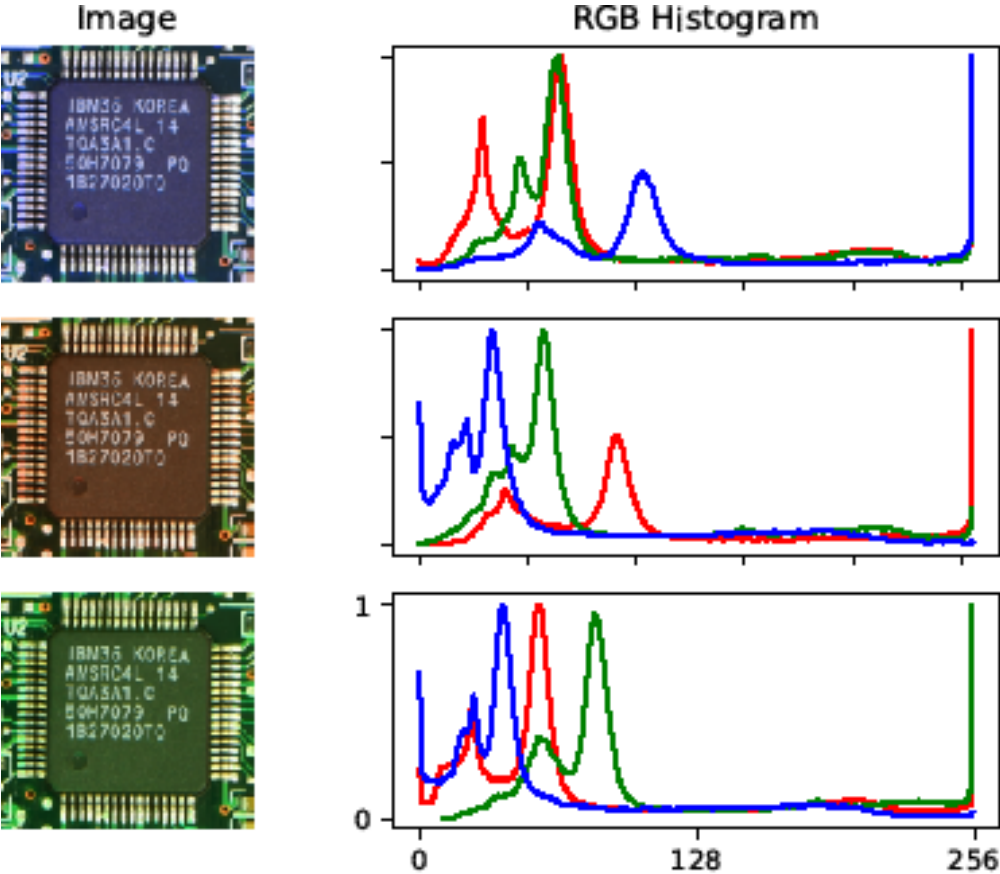


=

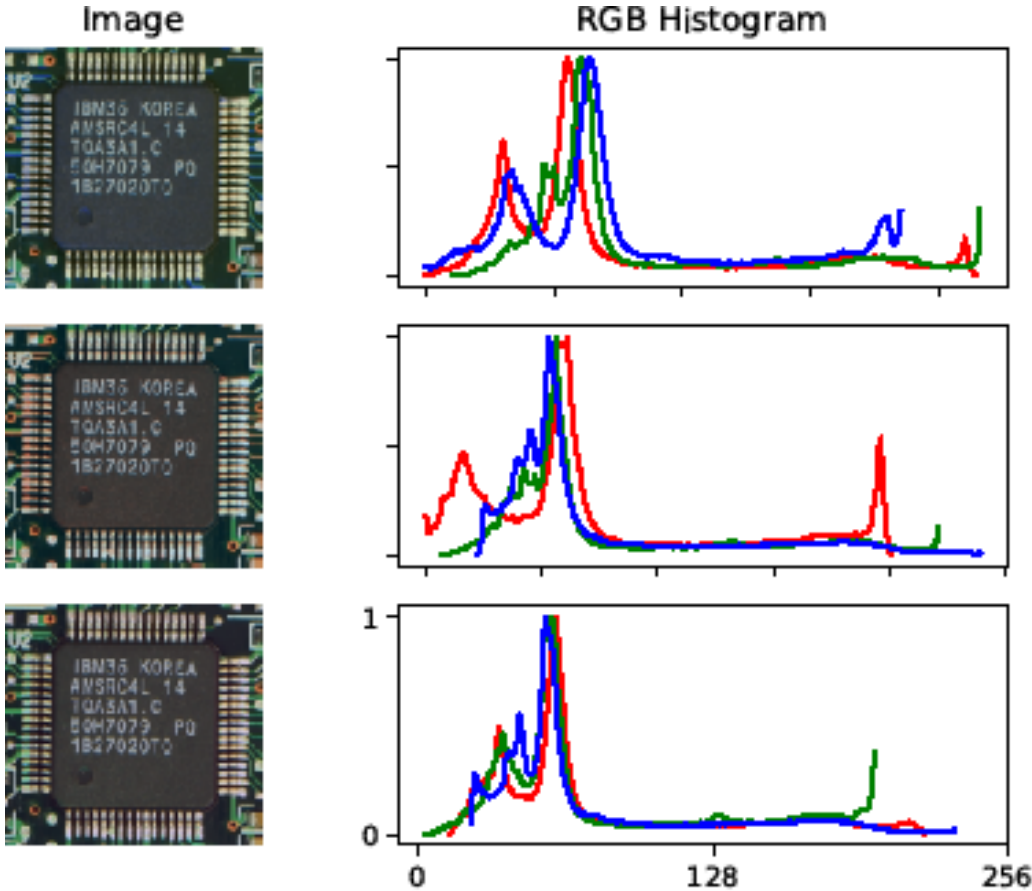


Imaging Conditions Solution: Color Checkers

Before Normalization



After Normalization

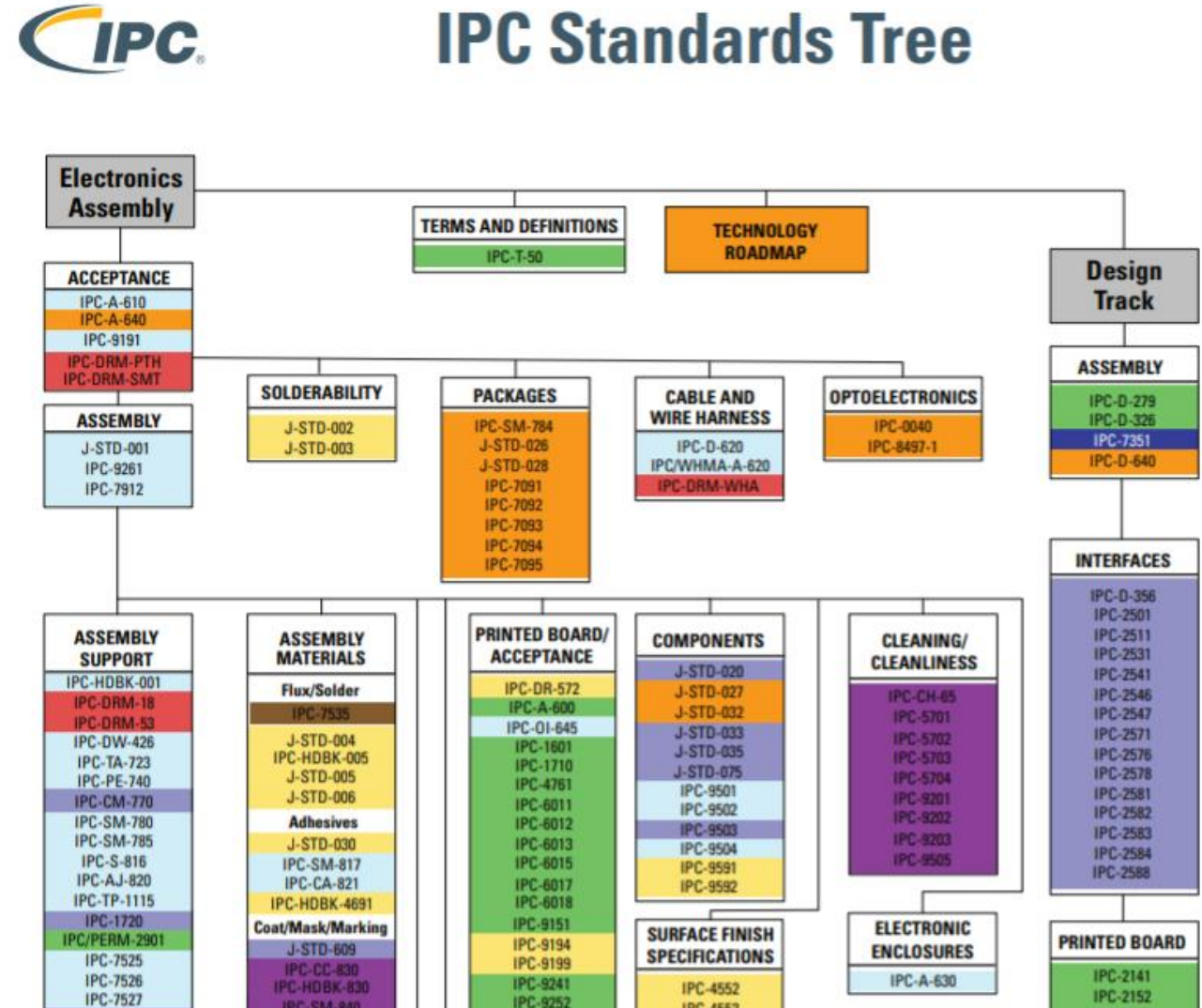


Much Better!

- LOTS of tuning required:
 - Color threshold
 - Enhancement parameters
 - Morphological image processing filter sizes
 - Etc. etc. etc.
- **IP/CV, alone is not sufficient to handle inherent board or component variations. What is?**

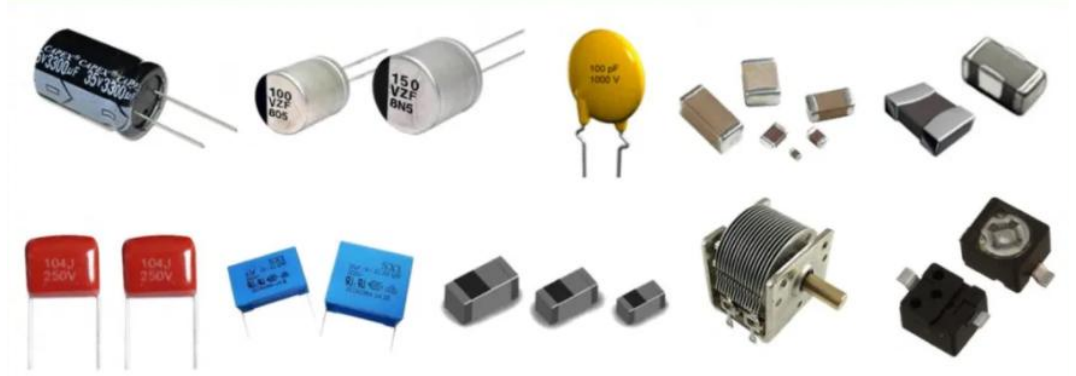
- **Machine Learning (ML):**
 - Analogy: child that's really really good at math → good at seeing patterns
 - BUT, child trusts everything you tell them → information (data) you give it must be VERY helpful
- **Challenge: Memorization, but cannot extrapolate (overtraining)**
 - **Solution 1: MORE DATA (expensive)**
 - Give the ML algorithm more examples and it learns...
 - **Solution 2: Incorporate domain knowledge**
 - Help the ML algorithm determine what to study

- PCB Design Best Practices
- CAD Design Rule Checks
- Institute of Printed Circuits (IPC) Standards
 - Participating Companies: Agilent, Apple, Boeng, Cisco, Dell, GE, Hewlett-Packard, IBM, Intel, Lenovo, Logitech, Microsoft, Motorola, Thermo Fisher, Xerox, etc. [7]

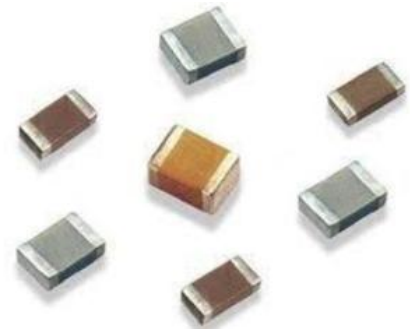


Human-Encoded Knowledge [8]

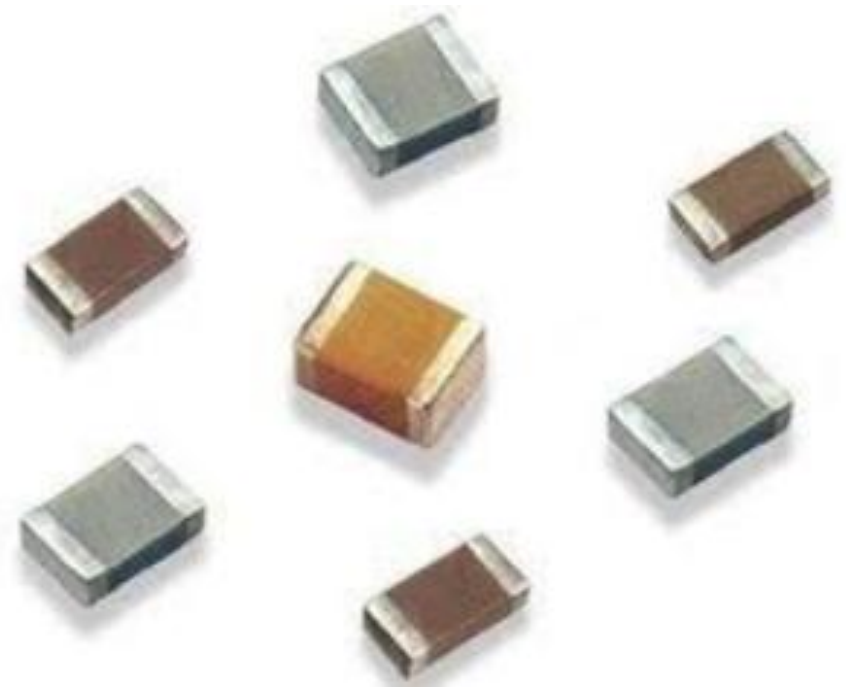
- **Example: consider just resistors and capacitors**
 - Large variety...



- **BUT, >90% look like this**



- What differences do you spot?



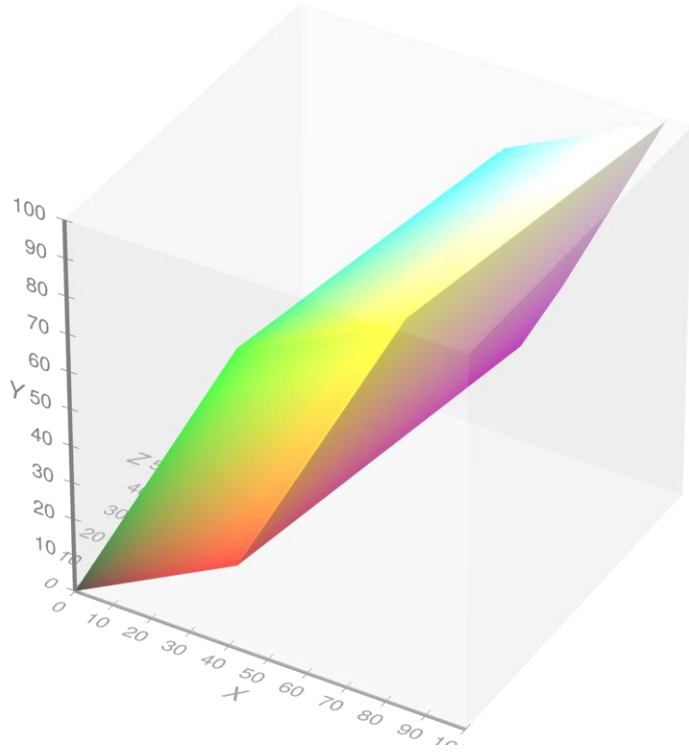
- **What differences do you spot?**
 - resistors tend to be black, capacitors tend to be brown, tan, or grey
 - resistors tend to have text, capacitors do not
 - resistors tend to be more rectangular, capacitors tend to be more rounded

IP/CV!

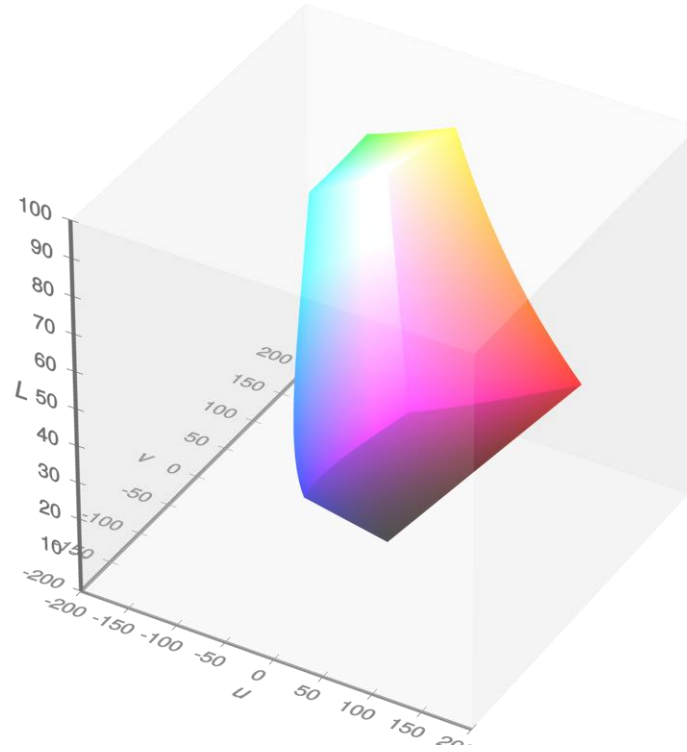
- color
- texture
- shape



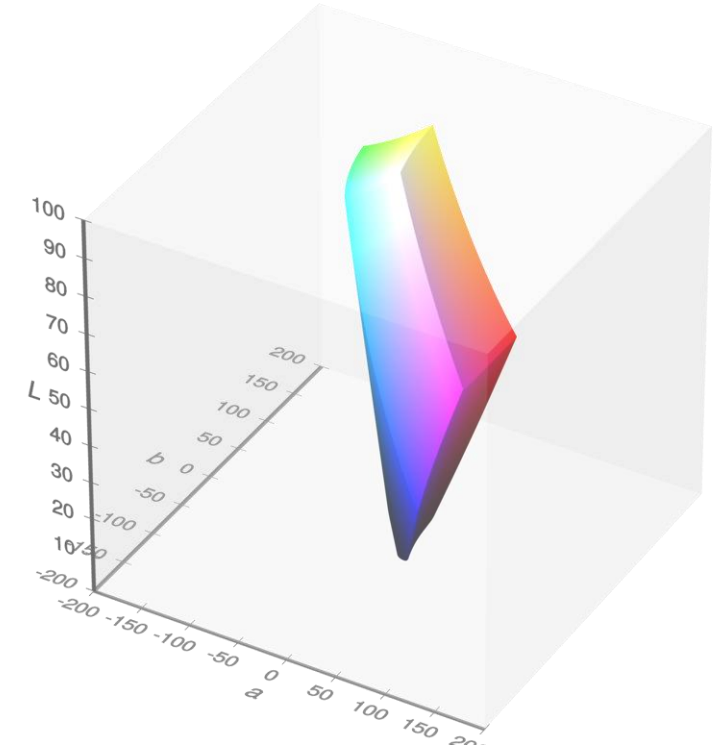
- **Color Model** = abstract numerical model that describes and organizes colors in a quantitative manner



CIE XYZ



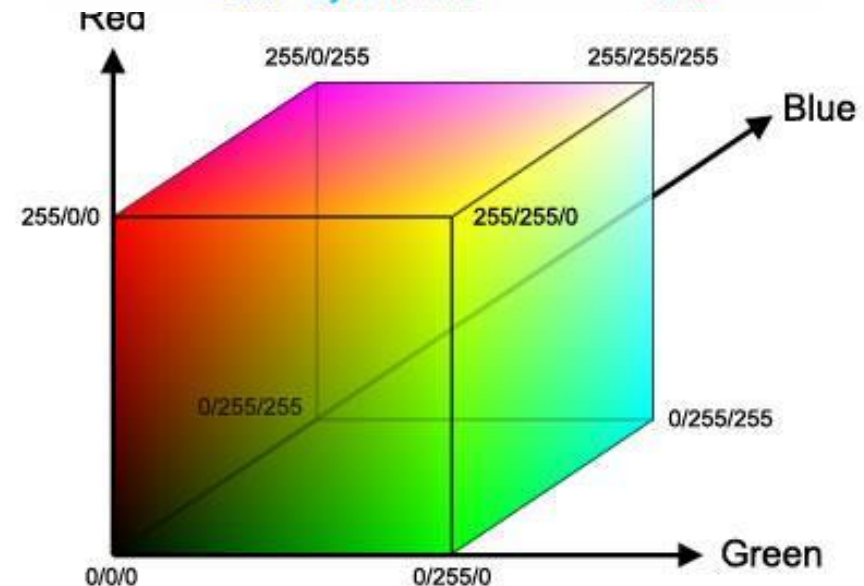
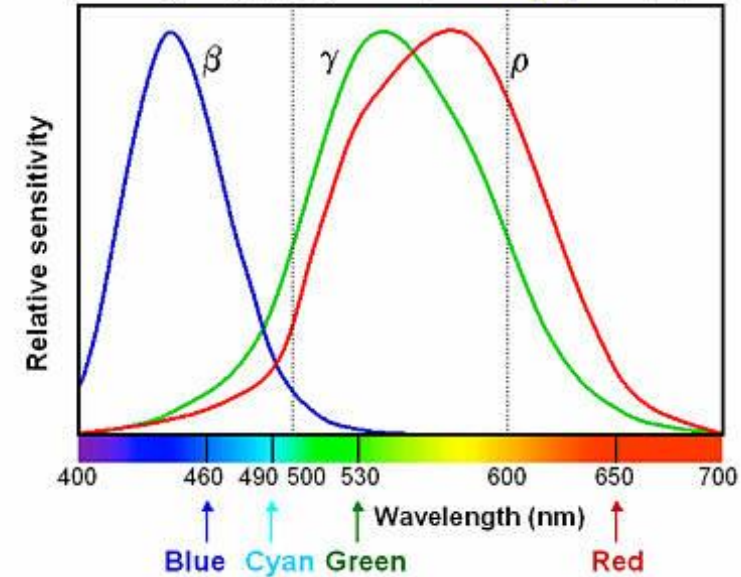
CIE LUV



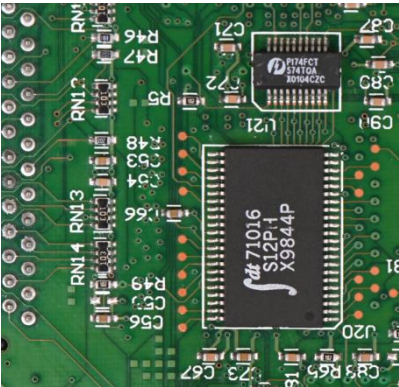
CIE LAB

- **RGB: standard additive color model, based on human trichromacy**
- Red
 - Long wavelength, 564–580 nm
 - Range: [0, 255]
- Green
 - Med wavelength, 534–545 nm
 - Range: [0, 255]
- Blue
 - Short wavelength, 420–440 nm
 - Range: [0, 255]

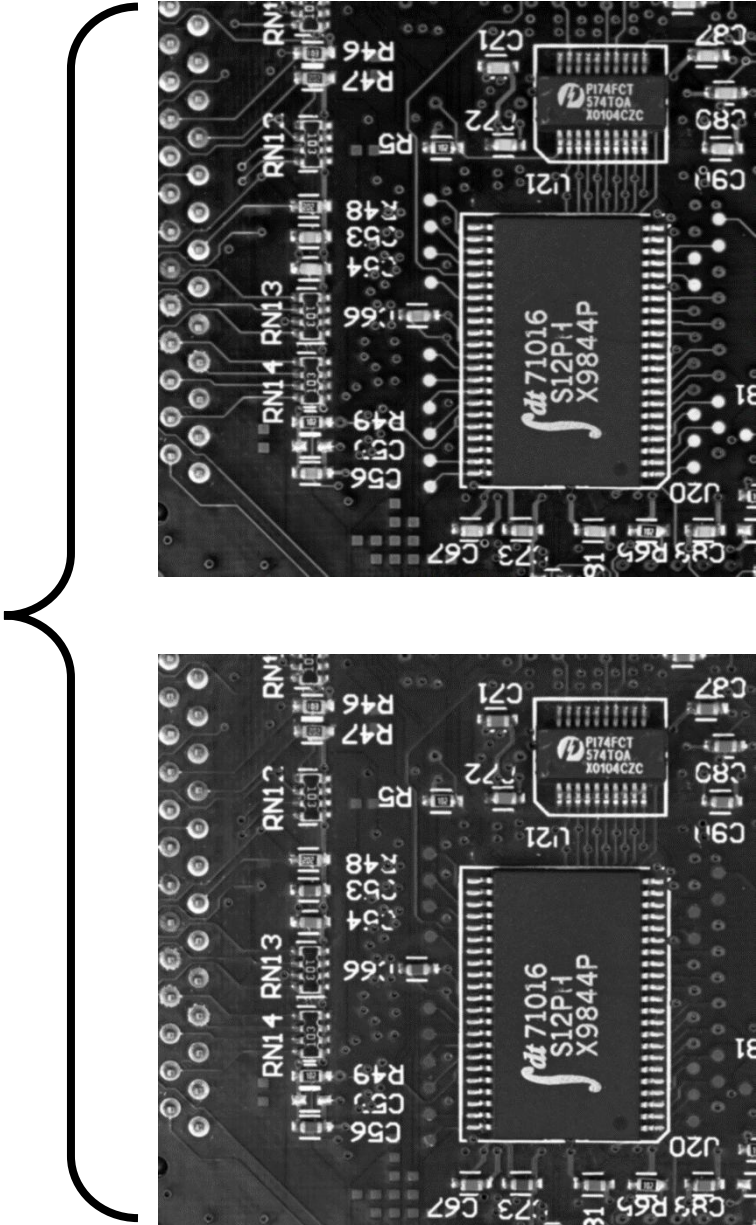
Human spectral sensitivity to color
Three cone types (ρ , γ , β) correspond *roughly* to R, G, B.



IP/CV: Color - RGB

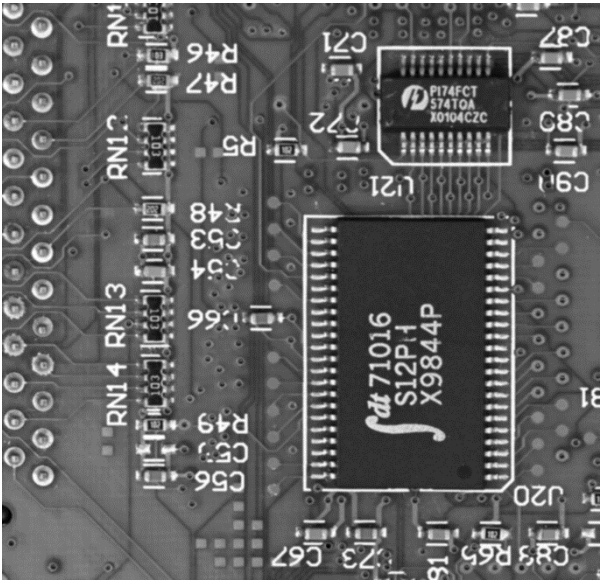


RGB



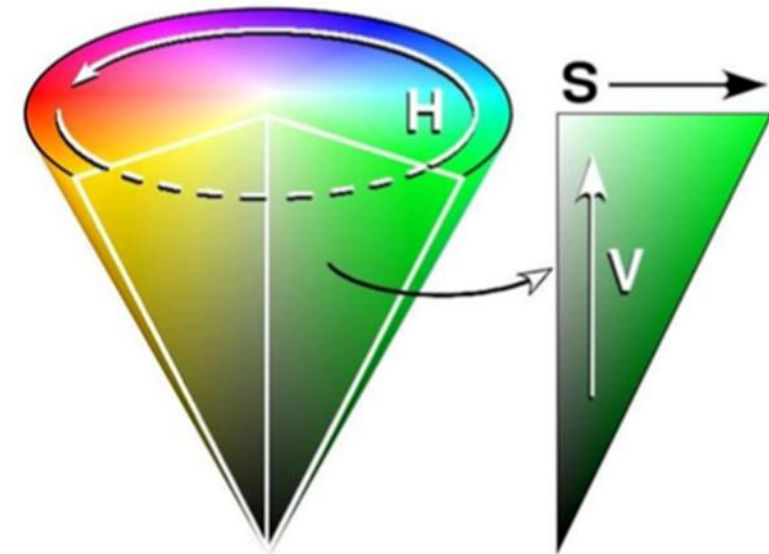
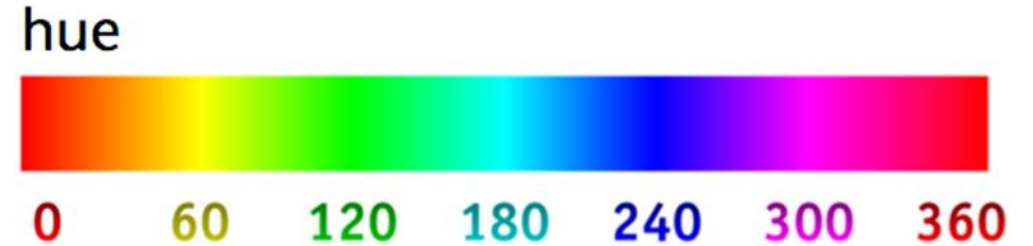
R

B

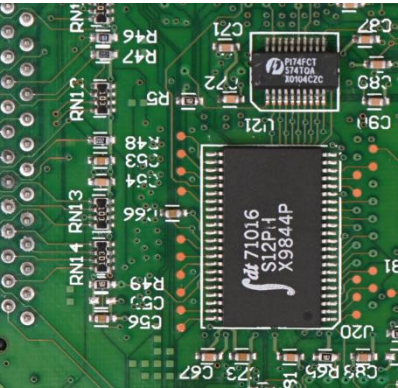


G

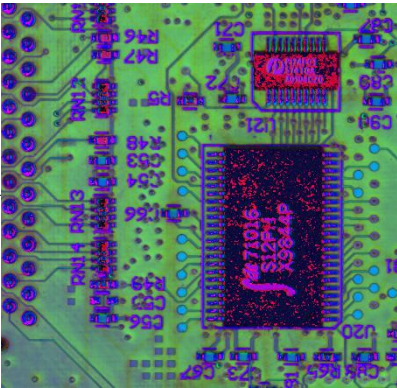
- **HSV: human-interpretable color space**
- Hue
 - color dominant wavelength
 - Range in degrees: [0, 360]
- Saturation
 - how much the color spectral distribution – colorfulness- is around a certain wavelength
 - Range: [0, 1]
- Value
 - the amount of gray, close to human perception
 - Range: [0, 1]



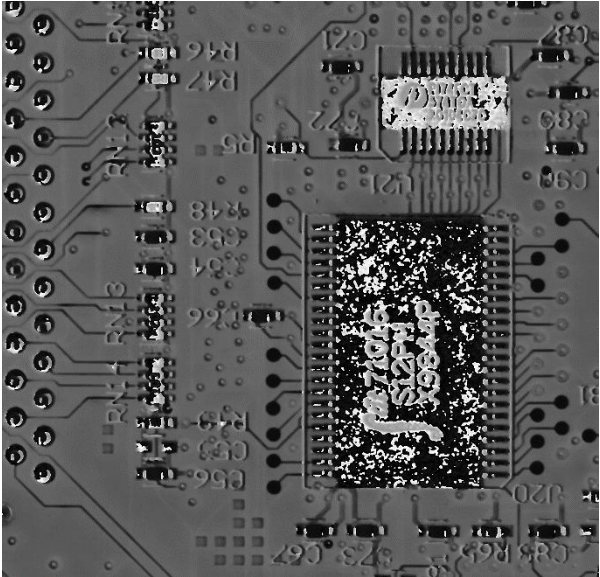
IP/CV: Color - HSV



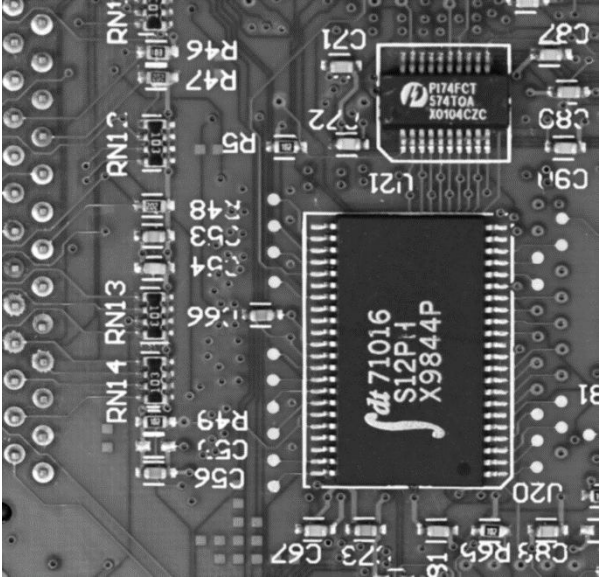
RGB



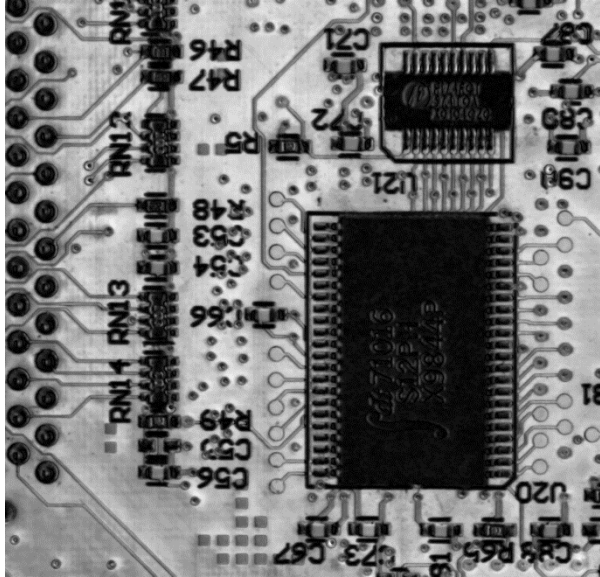
HSV



H



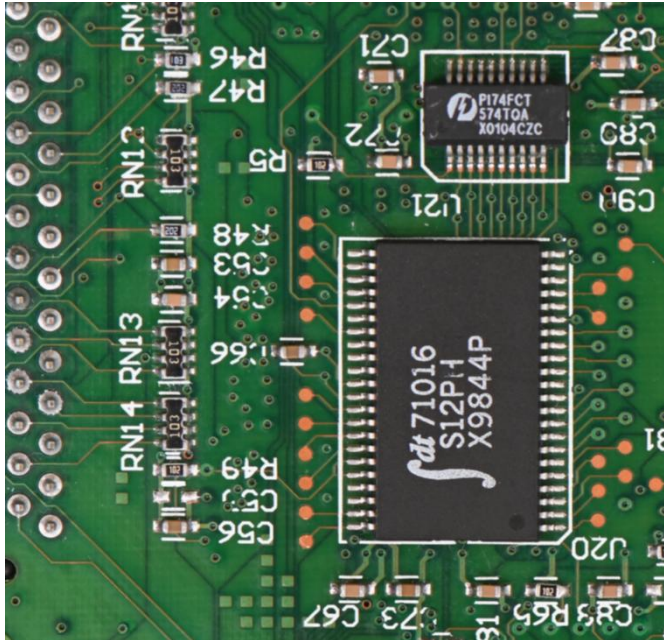
V



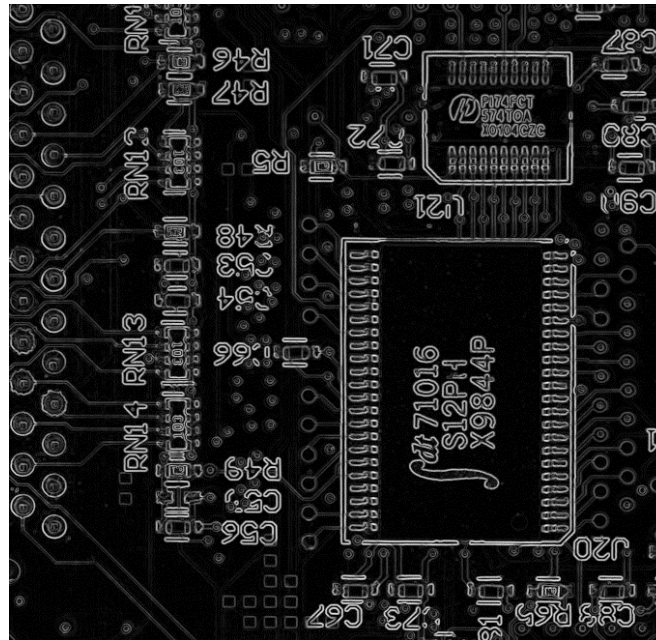
S

- Global Shape Features

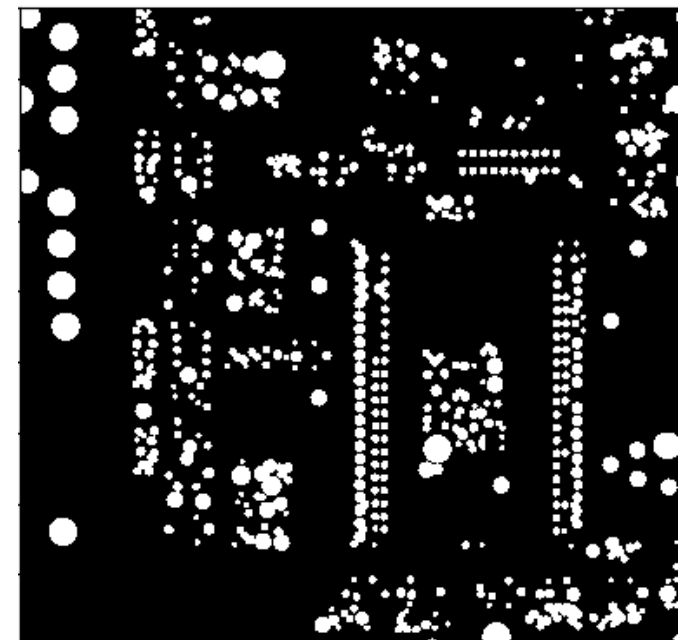
Original Image



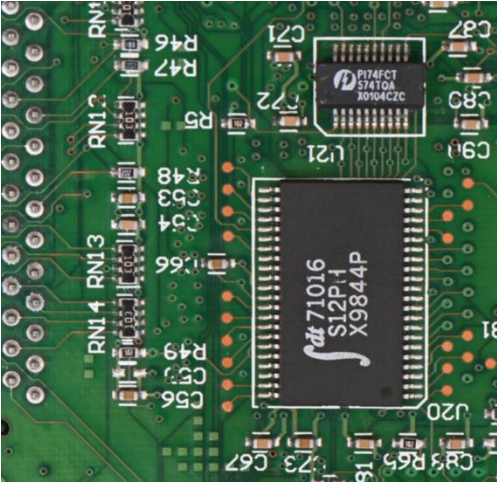
Edge Detection



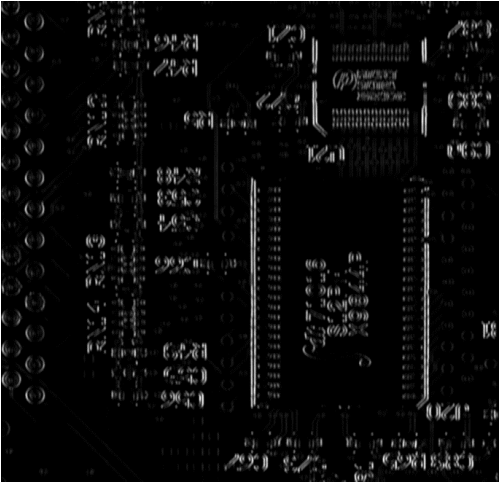
Blob Detection



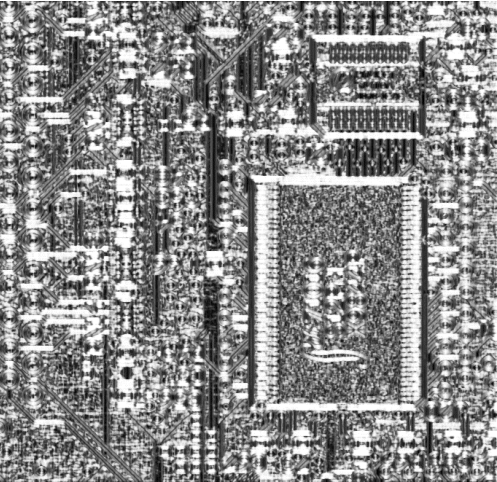
Original Image



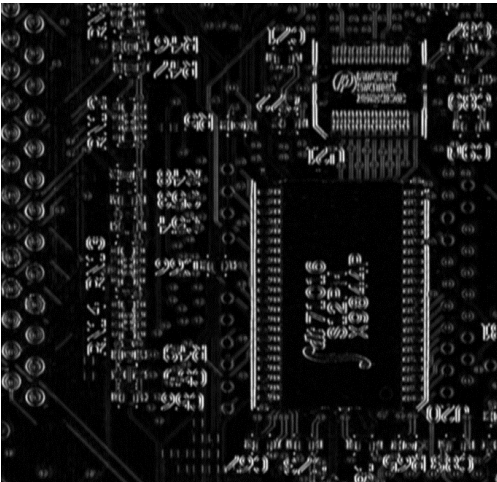
Contrast



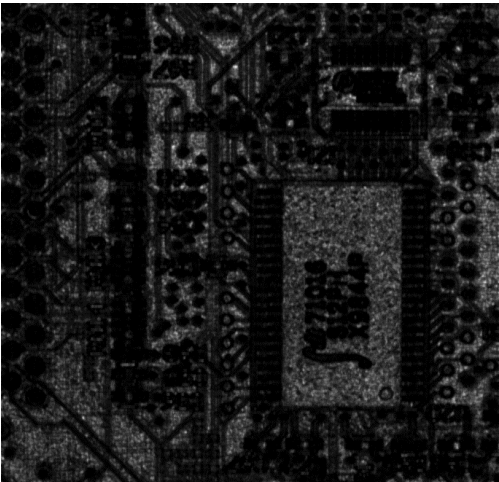
Correlation



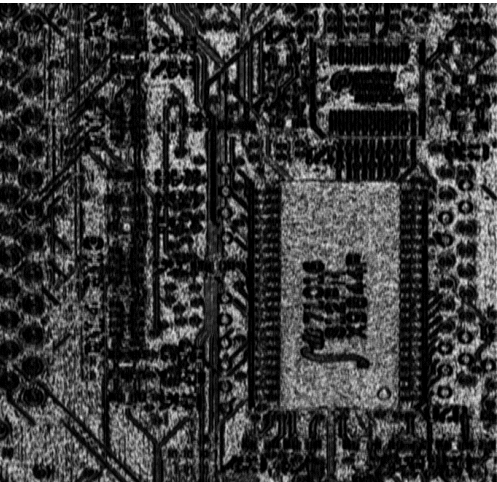
Dissimilarity



Energy



Homogeneity



- **Image Processing (IP) vs. Computer Vision (CV)**
- **IP/CV role in HW Assurance**
- **IP/CV Applications: Verification and AutoBoM**
- **AutoBoM challenges:**
 - **imaging conditions → color checker normalization**
 - **board/component variations → machine learning + domain knowledge**
- **How to encode domain knowledge?**
 - **3 types of features: color, shape, texture**

- [1] R. C. Gonzalez and R. E. Woods, *Digital image processing*. New York, NY: Pearson, 2018.
- [2] Shih, F.Y.: *Image processing and pattern recognition: fundamentals and techniques*. IEEE Press; Wiley (2010)
- [3] Moganti, M., Ercal, F., Dagli, C.H., Tsunekawa, S.: Automatic pcb inspection algorithms: A survey. *Computer Vision and Image Understanding*63(2),287–313 (1996). DOI 10.1006/cviu.1996.0020
- [4] Mcloughlin, “Secure embedded systems: The threat of reverse engineering,”*Parallel and Distributed Systems, International Conference on*,vol. 0, pp. 729–736, 12 2008.
- [5] S. E. Quadir, J. Chen, D. Forte, N. Asadi, S. Shahbazmohamadi,L. Wang, J. Chandy, and M. Tehranipoor, “A survey on chip to systemreverse engineering,”*J. Emerg. Technol. Comput. Syst.*, vol. 13, no. 1,4 2016.
- [6] <https://www.pinterest.com/pin/379357968609448874/>
- [7] <http://www.ipc.org/>
- [8] <http://www.electronicandyou.com/blog/electronic-components>
- [9] "IEC 61966-2-1:1999". IEC Webstore. International Electrotechnical Commission. Retrieved 3 March 2017
- [10] US patent 2375966, Valensi, Georges, "System of television in colors", published 1945-05-15